

Features

1) Very fast switching

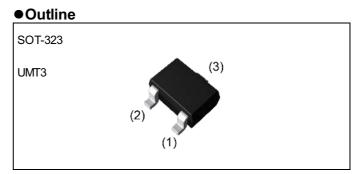
5) Halogen Free.

V <sub>DSS</sub>	60V
R <sub>DS(on)</sub> (Max.)	2.4Ω
Ι <sub>D</sub>	±310mA
P <sub>D</sub>	300mW

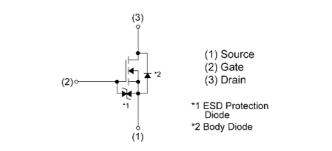
2) Ultra low voltage drive (2.5V drive)

4) Pb-free lead plating ; RoHS compliant.

3) ESD protection up to 2kV (HBM)



## ●Inner circuit



# Packaging specifications

		Packing	Embossed Tape
		Reel size (mm)	180
● Application	Туре	Tape width (mm)	8
Switching circuits		Quantity (pcs)	3000
Low-side loadswitch		Taping code	T106
Relay driver		Marking	VD
		•	

#### • Absolute maximum ratings (T<sub>a</sub> = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V <sub>DSS</sub>	60	V
Continuous drain current	I <sub>D</sub>	±310	mA
Pulsed drain current	I <sub>DP</sub> *1	±1.24	A
Gate - Source voltage	V <sub>GSS</sub>	±20	V
Dower discipation	P <sub>D</sub> *2	300	mW
Power dissipation	P <sub>D</sub> *3	200	mW
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T <sub>stg</sub>	-55 to +150	°C

#### •Thermal resistance

Deremeter	C) mah al	Values			1 1
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registeres junction embient	$R_{thJA}^{*2}$	-	-	416	°C/W
Thermal resistance, junction - ambient	$R_{thJA}^{*3}$	-	-	625	°C/W

# •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = 1 \text{mA}$		63.7	-	mV/°C
Zero gate voltage drain current	I <sub>DSS</sub>	$I_{DSS}$ $V_{DS} = 60V, V_{GS} = 0V$		-	1	μA
Gate - Source leakage current	I <sub>GSS</sub>	$I_{GSS}$ $V_{GS} = \pm 20V, V_{DS} = 0V$		-	±10	μA
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{GS(th)}$ $V_{DS}$ = 10V, $I_D$ = 1mA		-	2.3	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$			-2.8	-	mV/°C
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 310mA	-	1.7	2.4	
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 310mA	-	2.1	3.0	Ω
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 10mA	-	3.0	12	
Forward Transfer Admittance	Y <sub>fs</sub>  *4	V <sub>DS</sub> = 10V, I <sub>D</sub> = 310mA	250	-	-	mS

\*1 Pw $\leq$ 10µs , Duty cycle $\leq$ 1%

\*2 Mounted on a ceramic board (30mm×30mm×0.8mm)

\*3 Mounted on a FR4 board (20mm×12mm×0.8mm, Cu pad=0.8mm<sup>2</sup>)

\*4 Pulsed



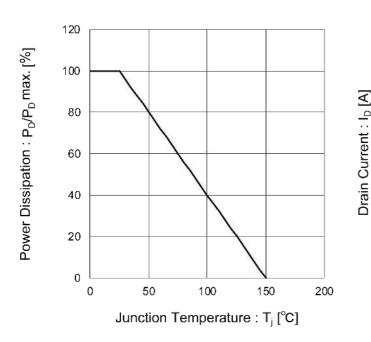
# • Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Sumphal	Conditions	Values			Unit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	15	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 30V	-	4.5	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	2	-		
Turn - on delay time	$t_{d(on)}^{*4}$	$V_{DD} \simeq 30V, V_{GS} = 10V$	-	3.5	-		
Rise time	t <sub>r</sub> *4	I <sub>D</sub> = 100mA	-	5	-	20	
Turn - off delay time	$t_{d(off)}^{*4}$	$R_L \simeq 300\Omega$	-	18	-	ns	
Fall time	t <sub>f</sub> *4	R <sub>G</sub> = 10Ω	-	28	-		

# •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

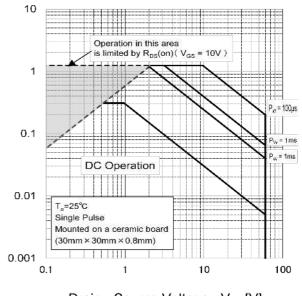
Parameter	Symbol	Conditions	Values			Unit
	Symbol Conditions		Min.	Тур.	Max.	Unit
Continuous forward current	۱ <sub>s</sub>	$T = 25^{\circ}$	-	-	250	mA
Pulse forward current	$I_{SP}^{*1}$	T <sub>a</sub> = 25°C	-	-	1.24	А
Forward voltage	$V_{SD}^{*4}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = 250mA	-	-	1.2	V





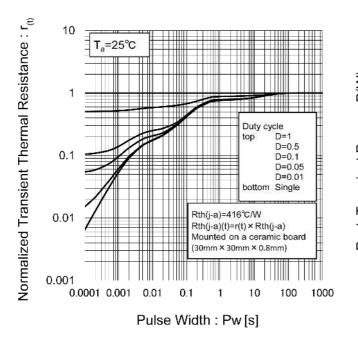
## Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

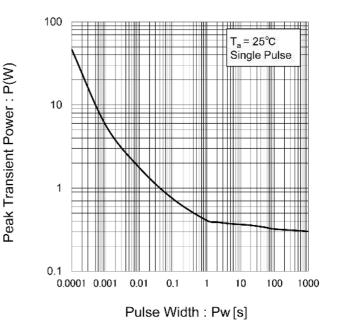


Drain - Source Voltage :  $V_{DS}[V]$ 

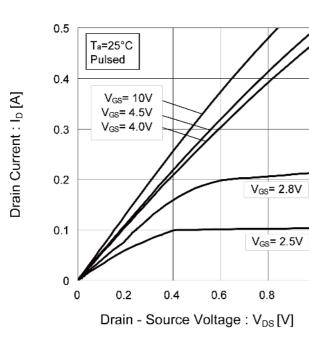
Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



# Fig.4 Single Pulse Maximum Power dissipation







### Fig.5 Typical Output Characteristics(I)

#### 0.5 Ta=25°C V<sub>GS</sub>= 10V Pulsed V<sub>GS</sub>= 4.5V V<sub>GS</sub>= 4.0V 0.4 0.3 V<sub>GS</sub>= 2.8V 0.2 V<sub>GS</sub>= 2.5V 0.1 0 2 6 10 4 8 0 Drain - Source Voltage : V<sub>DS</sub> [V]

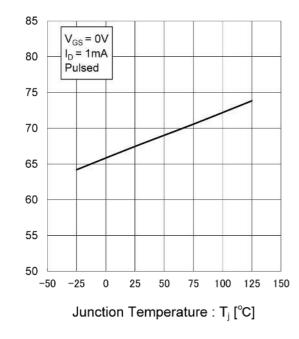
Drain Current : I<sub>D</sub> [A]

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# Fig.6 Typical Output Characteristics(II)

# Fig.7 Breakdown Voltage vs. Junction Temperature

Drain-Source Breakdown Voltage : V<sub>(BR)DSS</sub> [V]





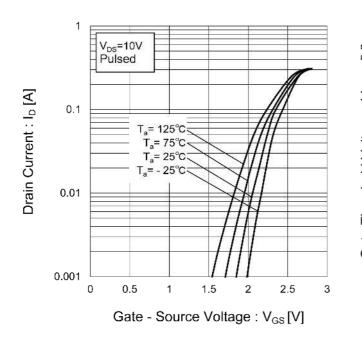
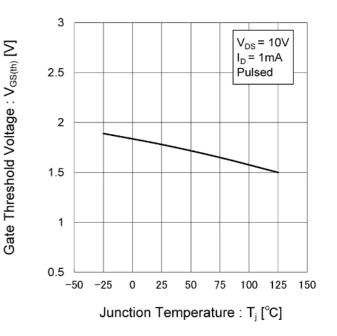
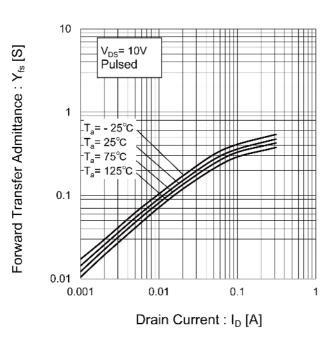


Fig.8 Typical Transfer Characteristics

# Fig.9 Gate Threshold Voltage vs. Junction Temperature



# Fig.10 Forward Transfer Admittance vs. Drain Current





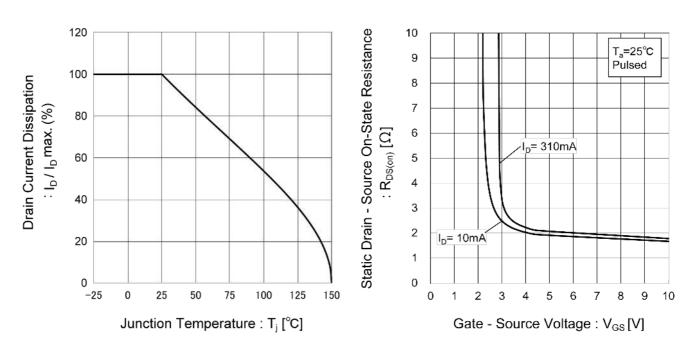


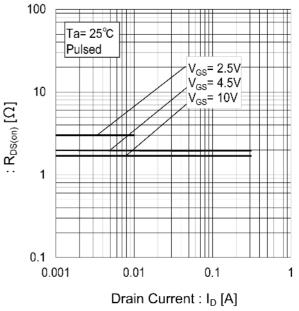
Fig.11 Drain Current Derating Curve

## Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

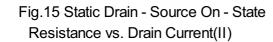
Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

3 Static Drain - Source On-State Resistance Static Drain - Source On-State Resistance V<sub>GS</sub> = 10V Pulsed 2.5 2  $: R_{DS(on)} [\Omega]$  $I_{D} = 0.31A$ 1.5 1 0.5 25 50 75 100 150 0 125 -50 -25 Junction Temperature : T<sub>i</sub> [°C]

Fig.14 Static Drain - Source On - State Resistance vs. Drain Current(I)







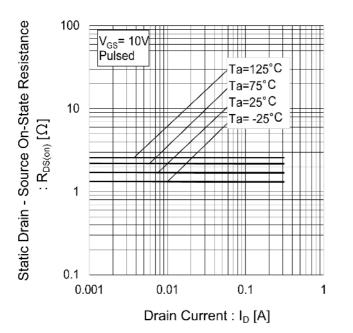


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current(III)

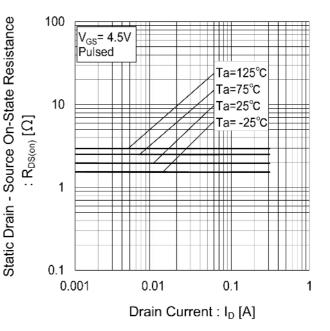
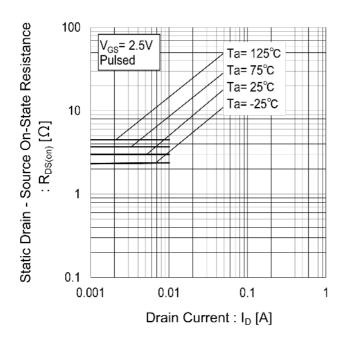
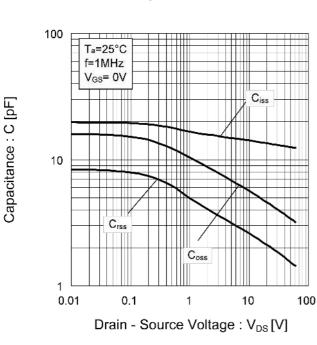


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current(IV)

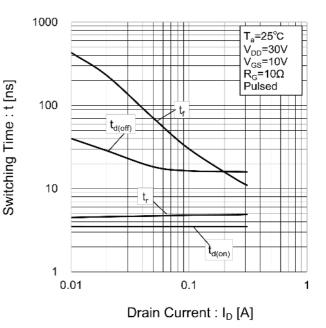




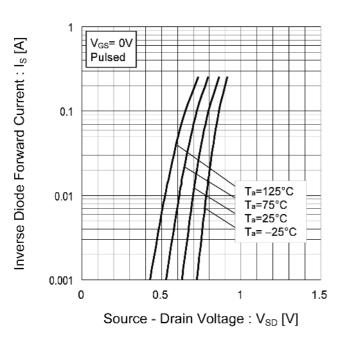


# Fig.18 Typical Capacitance vs. Drain -Source Voltage

Fig.19 Switching Characteristics

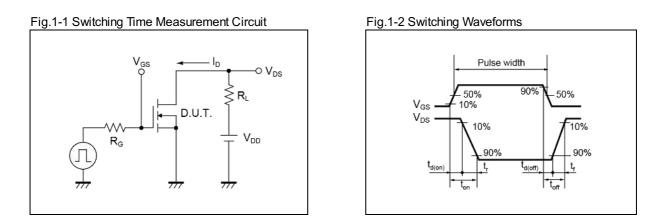


# Fig.20 Source Current vs. Source Drain Voltage





#### Measurement circuits



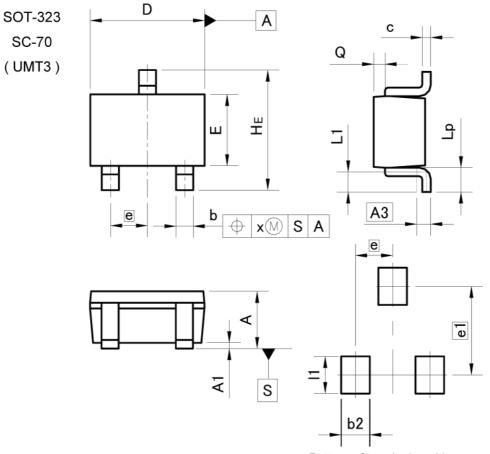
## Notice

1. This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.





### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INC	ICHES	
DIM	MIN	MAX	MIN	MAX	
A	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.3	25	0.0	10	
b	0.25	0.40	0.010	0.016	
с	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.65		0.0	26	
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
x	-370	0.10		0.004	
	MILIM	ETERS	INC	HES	
	MIN	MAX	MIN	MAX	
b2	<u>1</u>	0.50	3 <u>24</u>	0.020	
e1	1.	55	0.0	61	
11	-	0.65	1 1	0.026	

Dimension in mm/inches



# Notice

#### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (<sup>Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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